

Product Compliance Declaration

Please see <u>www.molex.com</u> for the most up-to-date information.

Contact Information						
Name	Molex Product Compliance	E-Mail	Product.Compliance@molex.com			
Part Inform	ation					
Part Number	0015978082	Part Weight	3.803G			
Part Name	MiniFit TPA RA Hdr /Flg Tin 8Ckt					

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
MiniFit TPA RA Hdr /Flg Tin 8Ckt	Assembly		100	3.803
.650 X .042 Sq. Bando pin 222 Matte Tin	Assembly		16.6185	0.632
0.650 X .042 Sq Bando Pin 999	Component		16.5133	0.628
Cartridge Brass 70% Unplated	Material		16.5133	0.628
Copper	Substance	7440-50-8	11.5593	0.4396
Zinc (metal)	Substance	7440-66-6	4.954	0.1884
Tin Plating	Material		0.0655	0.00249
Tin	Substance	7440-31-5	0.0655	0.00249
Nickel Plating	Material		0.0397	0.00151
Nickel	Substance	7440-02-0	0.0397	0.001509
Further Additives, not to declare	Substance	system	4E-06	2E-07
1.083 X .042 Sq. Bando Pin 222 Matte Tin	Assembly		28.2935	1.076
1.083 X .042 Sq Bando Pin 999	Component		27.8727	1.06

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Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Cartridge Brass 70% Unplated	Material		27.8727	1.06
Copper	Substance	7440-50-8	19.5109	0.742
Zinc (metal)	Substance	7440-66-6	8.3618	0.318
Tin Plating	Material		0.263	0.01
Tin	Substance	7440-31-5	0.263	0.01
Nickel Plating	Material		0.1578	0.006
Nickel	Substance	7440-02-0	0.1578	0.005999
Further Additives, not to declare	Substance	system	2E-05	6E-07
MiniFit TPA RA Hdr /Flg 8Ckt	Component		55.0881	2.095
PBT-FR(17)	Material		55.0881	2.095
PBT	Substance		36.0827	1.372225
Antimonytrioxide	Substance	1309-64-4	5.5088	0.2095
Further Additives, not to declare	Substance	system	5.2334	0.199025
Flame Retardant, ISO 1043-4 FR(17)	Substance		8.2632	0.31425

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

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REACH-SVHC Declaration Information

Regulatory Revision D(2020)4578-DC (25 June 2020)

Contained Substances Exceeding Threshold

None

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added	
Lead	Cartridge Brass 70% (CA260)	*Note	350	Yes	
Lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	500	Yes	
Antimonytrioxide	PBT-FR(17) *N		100,000	Yes	
Nickel	Ep-Ni *Note		997,500	Yes	
Copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes	

*Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Exemptions

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/ cm2/week)

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added	
Bromine and its compounds	PBT-FR(17)	900	150,000	Yes	

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Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Bromine and Chlorine combined	PBT-FR(17)	1,500	150,000	Yes

China ROHS Declaration Information

Part Number 0015978082						
Part Name MiniFit TPA RA Hdr /Flg Tin 8Ckt						
Part Information		Haz	zardous S	Substance	s	
Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
MiniFit TPA RA Hdr /Flg Tin 8Ckt	0	0	0	0	0	0
.650 X .042 Sq. Bando pin 222 Matte Tin	0	0	0	0	0	0
0.650 X .042 Sq Bando Pin 999	0	0	0	0	0	0
1.083 X .042 Sq. Bando Pin 222 Matte Tin	0	0	0	0	0	0
1.083 X .042 Sq Bando Pin 999		0	0	0	0	0
MiniFit TPA RA Hdr /Flg 8Ckt		0	0	0	0	0

Process Information

Component Plating / Surface Finish	BSn
Termination Base Alloy	Brass
Solder Alloy	N/A
Process Capability	WAVE
Maximum Exposure Time (seconds)	005
Maximum Process Temperature (C)	260
Maximum Cycles at Reflow Temperature	001
J-STD-020 Moisture Sensitivity Level	N/A

Aug 31, 2020

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